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Kind regards,

Team Nexperia



NPN resistor-equipped transistor; $R1 = 47 k\Omega$, $R2 = 22 k\Omega$ Rev. 1 – 2 July 2012 Product data s

Product data sheet

1. **Product profile**

1.1 General description

NPN Resistor-Equipped Transistor (RET) in a leadless ultra small DFN1006B-3 (SOT883B) Surface-Mounted Device (SMD) plastic package.

PNP complement: PDTA144WMB.

1.2 Features and benefits

- 100 mA output current capability
- Reduces component count
- Built-in bias resistors
- Reduces pick and place costs

1.3 Applications

- Low-current peripheral driver
- Control of IC inputs

- Simplifies circuit design
- AEC-Q101 qualified
- Leadless ultra small SMD plastic package
- Low package height of 0.37 mm
- Replaces general-purpose transistors in digital applications
- Mobile applications

1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	50	V
lo	output current		-	-	100	mA
R1	bias resistor 1 (input)	T _{amb} = 25 °C	33	47	61	kΩ
R2/R1	bias resistor ratio		0.37	0.47	0.57	



NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)		
2	G	GND (emitter)		3
3	0	output (collector)	2 Transparent top view DFN1006B-3 (SOT883B)	1 R2 R2 sym007

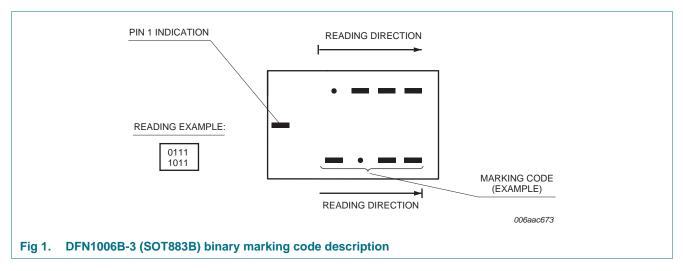
3. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PDTC144WMB	DFN1006B-3	Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.37 mm	SOT883B			

4. Marking

Table 4.	Marking codes
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Type number	Marking code
PDTC144WMB	0011 1111



NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω

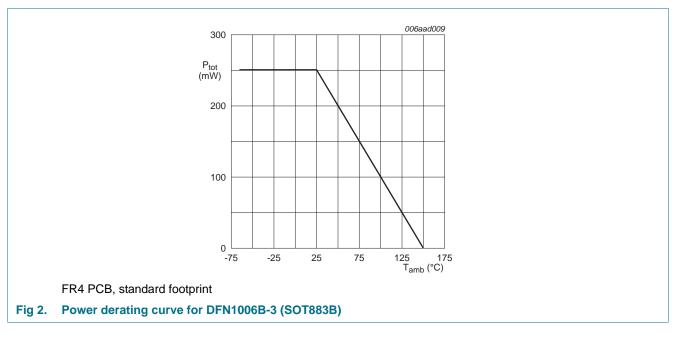
5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		,				
Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	50	V
V _{CEO}	collector-emitter voltage	open base		-	50	V
V _{EBO}	emitter-base voltage	open collector		-	10	V
VI	input voltage	positive		-	40	V
		negative		-	-10	V
lo	output current			-	100	mA
I _{CM}	peak collector current	pulsed; t _p ≤ 1 ms		-	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	<u>[1]</u>	-	250	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



6. Thermal characteristics

Table 6.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

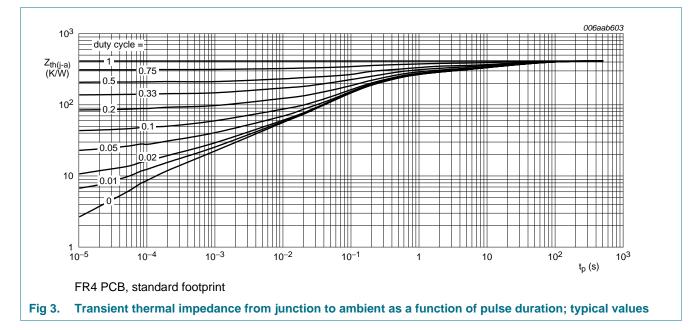
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Rev. 1 — 2 July 2012

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NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω



7. Characteristics

Table 7. Characteristics

Table 7.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	V_{CB} = 50 V; I _E = 0 A; T _{amb} = 25 °C		-	-	100	nA
I _{CEO}	collector-emitter cut-off	$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A}; \text{ T}_{amb} = 25 \text{ °C}$		-	-	1	μA
	current	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}; T_j = 150 \text{ °C}$		-	-	5	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}; \text{ T}_{amb} = 25 \text{ °C}$		-	-	110	μA
h _{FE}	DC current gain	V_{CE} = 5 V; I _C = 5 mA; T _{amb} = 25 °C		60	-	-	
V _{CEsat}	collector-emitter saturation voltage	I_C = 10 mA; I_B = 0.5 mA; T_{amb} = 25 °C		-	-	150	mV
V _{I(off)}	off-state input voltage	V_{CE} = 5 V; I_{C} = 100 $\mu A;$ T_{amb} = 25 °C		-	1.7	1.2	V
V _{I(on)}	on-state input voltage	V_{CE} = 0.3 V; I_{C} = 2 mA; T_{amb} = 25 °C		4	2.7	-	V
R1	bias resistor 1 (input)	T _{amb} = 25 °C		33	47	61	kΩ
R2/R1	bias resistor ratio			0.37	0.47	0.57	
C _C	collector capacitance	V _{CB} = 10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C		-	-	2.5	pF
f _T	transition frequency	V_{CE} = 5 V; I _C = 10 mA; f = 100 MHz; T _{amb} = 25 °C	<u>[1]</u>	-	230	-	MHz

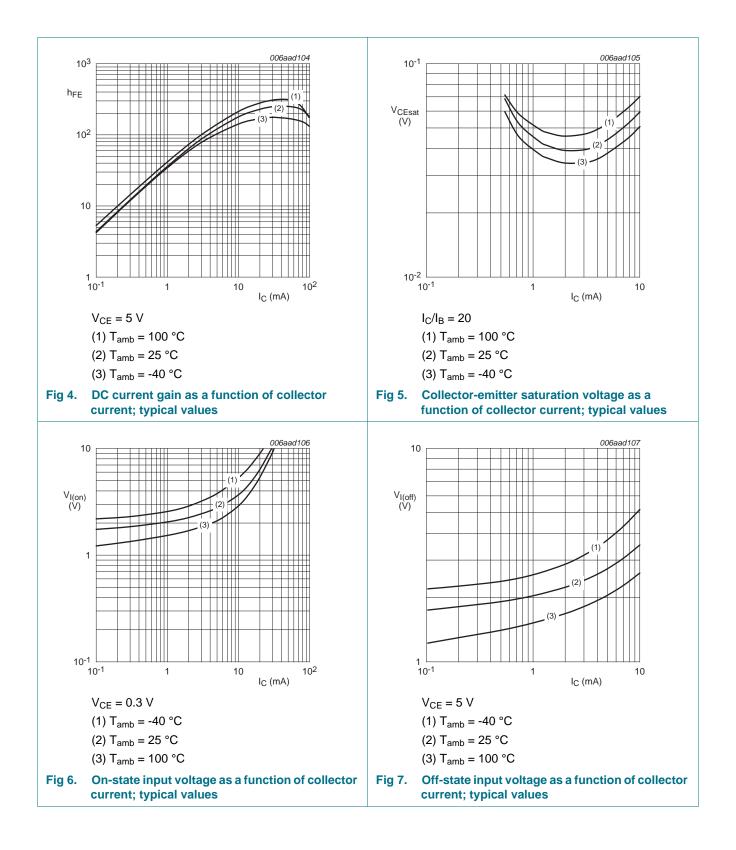
[1] Characteristics of built-in transistor.

PDTC144WMB Product data sheet

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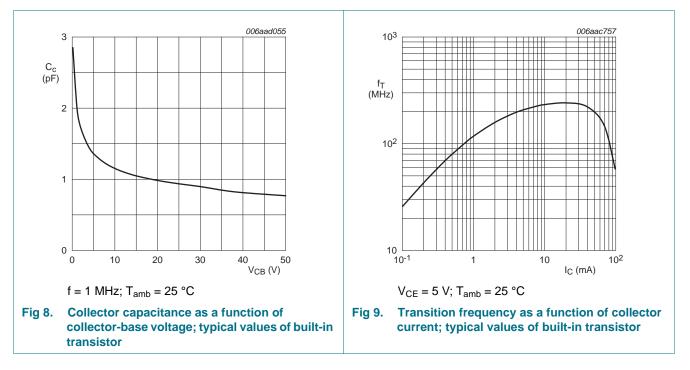
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NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω



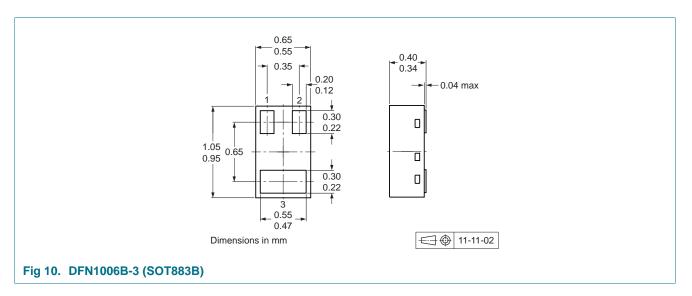
8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

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Package outline 9.



10. Soldering

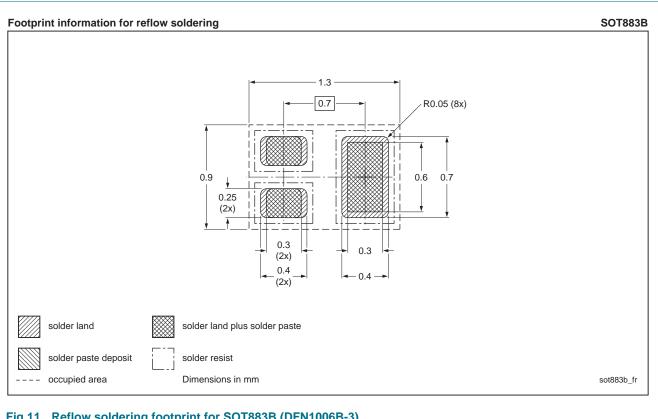


Fig 11. Reflow soldering footprint for SOT883B (DFN1006B-3)

PDTC144WMB **Product data sheet**

NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω

11. Revision history

Table 8. Revision h	e 8. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
PDTC144WMB v.1	20120702	Product data sheet	-	-	

12. Legal information

12.1 Data sheet status

Document status[1] [2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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Product data sheet

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